

MG1500FXF1US62

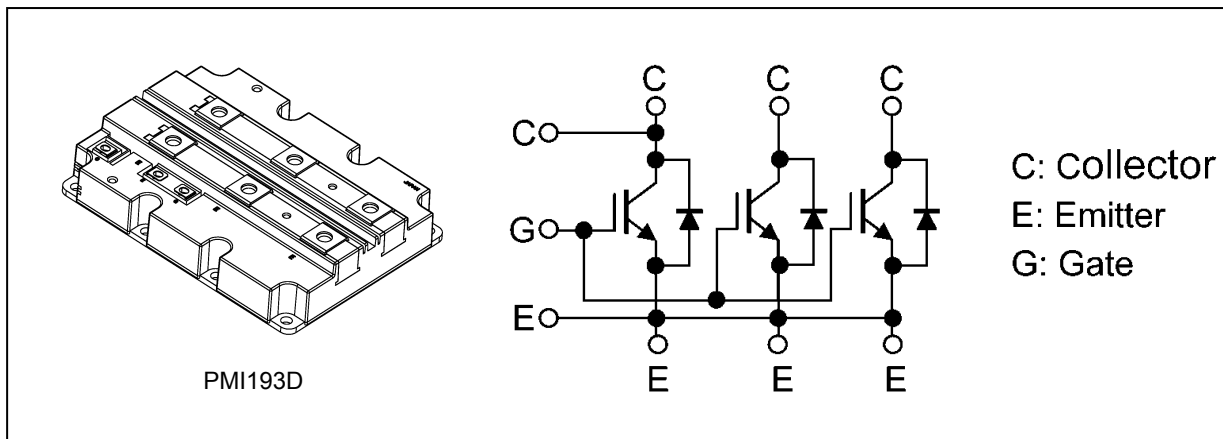
1. Applications

- High-Power Switching
- Motor Controllers

2. Features

- (1) Enhancement mode.
- (2) Electrodes are isolated from case.

3. Packaging and Internal Circuit Pin Assignment (Note)



Note: Although main E-terminals are connected internally, they cannot lead rating current.
Please connect main E-terminals and C-terminals individually with conductive wire capable of leading rating current.

Start of commercial production

2014-03

4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_C = 25 °C)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Collector-emitter voltage	V _{CES}			3300	V
Gate-emitter voltage	V _{GES}			±20	V
Collector current (RMS)	I _{C(RMS)}	(Note 1)		1500	A
Collector current (pulsed)	I _{CP}	(Note 2)	Peak turn-off current	3000	A
Non-repetitive peak forward surge current	I _{FSM}		10 ms (half-sine wave)	10	kA
Collector power dissipation	P _C			15600	W
Junction temperature	T _j			-40 to 150	°C
Storage temperature	T _{stg}			-40 to 150	°C
Isolation voltage	V _{isol}		AC 1 min	6000	V
Mounting torque	TOR		Terminal: M4/M8	2/7	N · m
			Mounting: M6	4	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: T_C = 100 °C, without switching losses.

Note 2: V_{CP} ≤ 3300 V, V_{CC} ≤ 2300 V, V_{GE} = ±15 V, R_{G(off)} = 2.4 Ω, T_j ≤ 150 °C, L_S ≈ 85 nH.

5. Thermal Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Thermal resistance (junction-to-case)	R _{th(j-c)}		Transistor part	—	—	8.0	K/kW
	R _{th(j-c)}		Diode part	—	—	16	
Thermal resistance (case-to-fin)	R _{th(c-f)}	(Note 1)	Per module	—	6.0	—	K/kW

Note 1: The heat radiation grease is recommended for use with semiconductor devices.

Apply a thin, even (100 to 200 μm) coating of grease.

6. Electrical Characteristics (Unless otherwise specified, $T_C = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Gate-emitter leakage current	I_{GES}		$V_{GE} = \pm 20\text{ V}$, $V_{CE} = 0\text{ V}$	—	—	± 100	nA
Collector-emitter cut-off current	I_{CES}		$V_{CE} = 3300\text{ V}$, $V_{GE} = 0\text{ V}$, $T_j = 150\text{ }^\circ\text{C}$	—	—	100	mA
Gate-emitter cut-off voltage	$V_{GE(off)}$		$I_C = 1.5\text{ A}$, $V_{CE} = 5\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$	3.8	4.3	4.7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		$I_C = 1500\text{ A}$, $V_{GE} = 15\text{ V}$, $T_j = 150\text{ }^\circ\text{C}$	—	3.2	3.8	V
Input capacitance	C_{ies}		$V_{CE} = 10\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$	—	175	—	nF
Switching time (turn-on delay time)	$t_{d(on)}$		$V_{CC} = 1800\text{ V}$, $I_C = 1500\text{ A}$, $V_{GE} = \pm 15\text{ V}$, $R_{G(on)} = 1.5\text{ }\Omega$, $R_{G(off)} = 2.4\text{ }\Omega$, $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$) See Fig. 6.1, 6.2	—	0.6	—	μs
Switching time (rise time)	t_r			—	0.2	—	μs
Switching time (turn-on time)	t_{on}			—	0.8	—	μs
Switching time (turn-off delay time)	$t_{d(off)}$			—	2.8	—	μs
Switching time (fall time)	t_f			—	1.7	—	μs
Switching time (turn-off time)	t_{off}			—	4.5	—	μs
Forward voltage	V_F			$I_F = 1500\text{ A}$, $V_{GE} = 0\text{ V}$, $T_j = 150\text{ }^\circ\text{C}$	—	3.0	3.8
Reverse recovery charge	Q_{rr}		$V_{CC} = 1800\text{ V}$, $I_F = 1500\text{ A}$, $V_{GE} = -15\text{ V}$, $R_{G(on)} = 1.5\text{ }\Omega$, $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$) See Fig. 6.1, 6.3	—	1300	—	μC
Peak reverse recovery current	I_{rr}			—	2450	—	A
Reverse recovery time	t_{rr}			—	0.6	—	μs
Turn-on switching loss	E_{on}		$V_{CC} = 1800\text{ V}$, $I_C = 1500\text{ A}$, $V_{GE} = \pm 15\text{ V}$, $R_{G(on)} = 1.5\text{ }\Omega$, $R_{G(off)} = 2.4\text{ }\Omega$, $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$) See Fig. 6.1, 6.2	—	1.5	—	J
Turn-off switching loss	E_{off}			—	2.5	—	J
Reverse recovery loss	E_{dsw}		$V_{CC} = 1800\text{ V}$, $I_F = 1500\text{ A}$, $V_{GE} = -15\text{ V}$, $R_{G(on)} = 1.5\text{ }\Omega$, $T_j = 150\text{ }^\circ\text{C}$ (Inductive load, $L_s \approx 85\text{ nH}$) See Fig. 6.1, 6.3	—	1.6	—	J

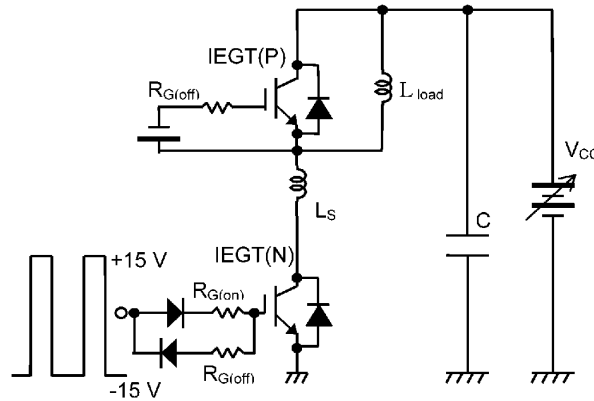


Fig. 6.1 Inductive Load Switching Test Circuit

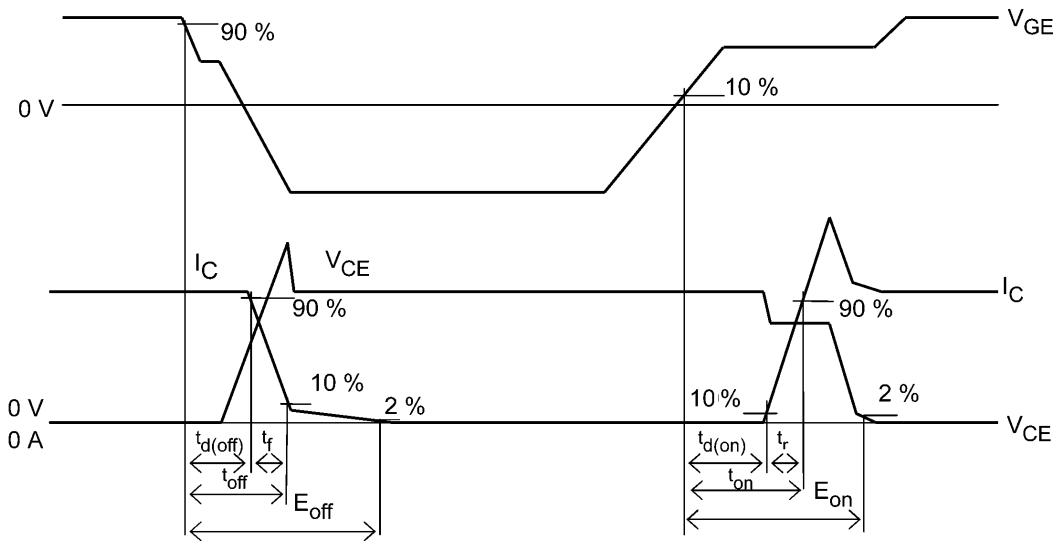


Fig. 6.2 Timing Chart (Transistor part)

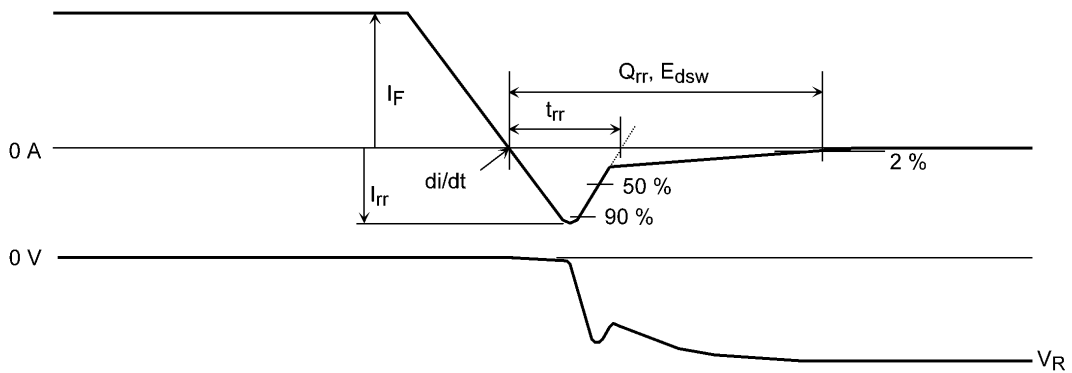


Fig. 6.3 Timing Chart (Diode part)

7. Characteristics Curves (Note)

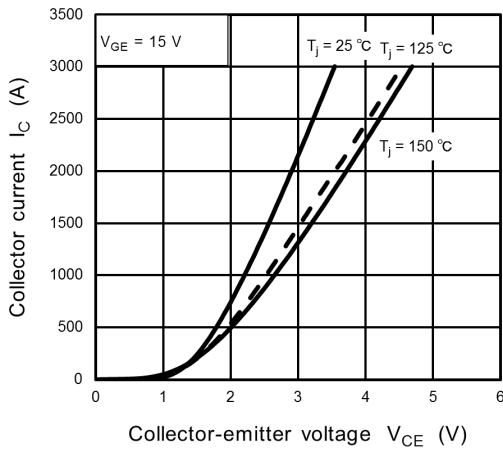


Fig. 7.1 $I_C - V_{CE}$

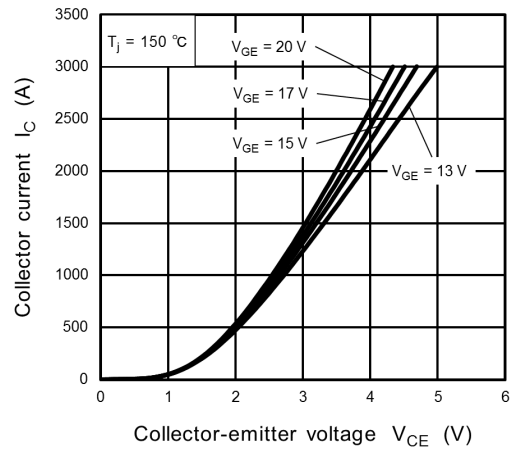


Fig. 7.2 Output characteristics

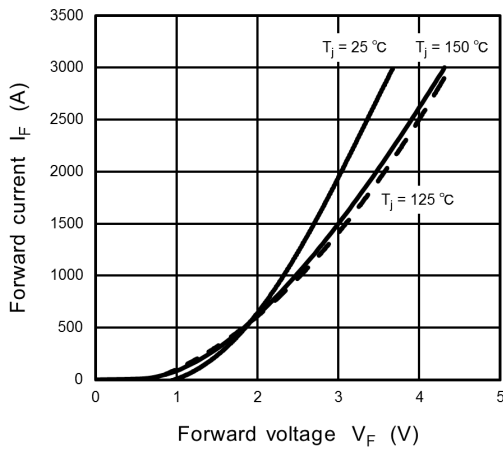


Fig. 7.3 $I_F - V_F$

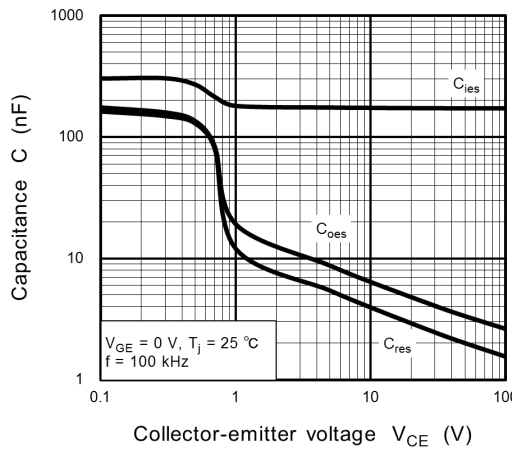


Fig. 7.4 $C_{ies}, C_{oes}, C_{res} - V_{CE}$

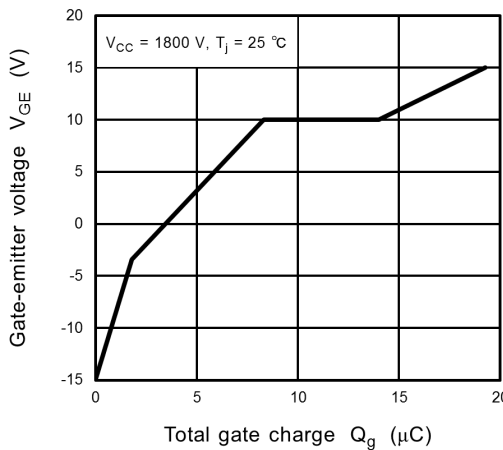


Fig. 7.5 $V_{GE} - Q_g$

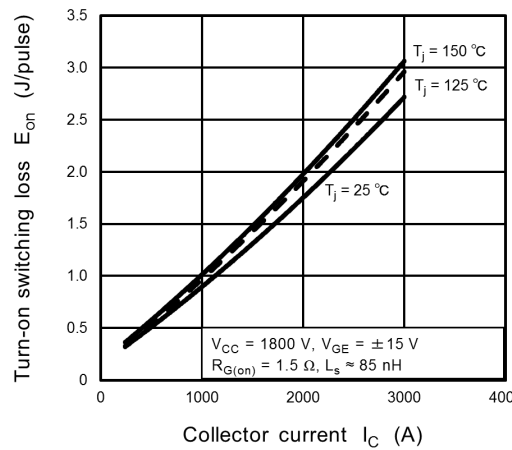


Fig. 7.6 $E_{on} - I_C$

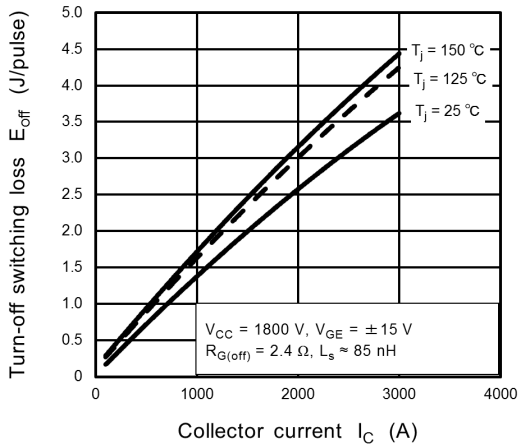


Fig. 7.7 $E_{off} - I_C$

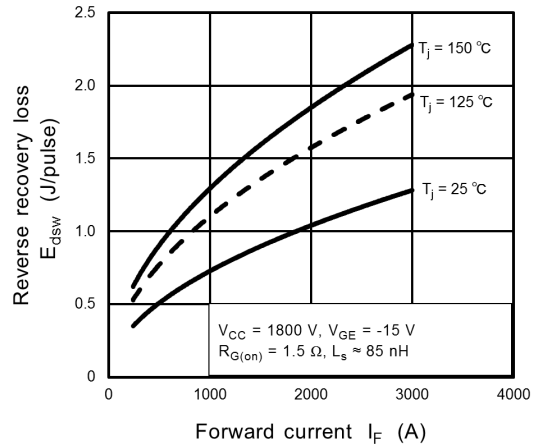


Fig. 7.8 $E_{dsw} - I_F$

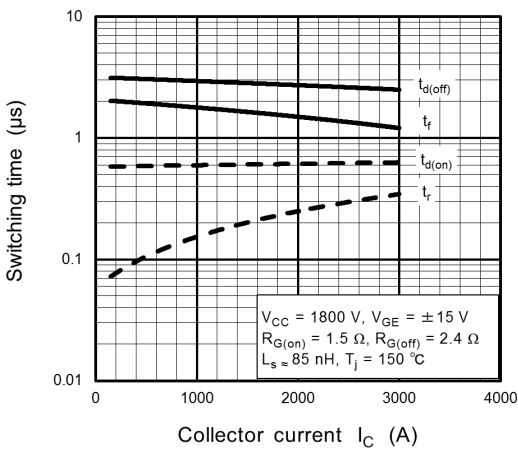


Fig. 7.9 $t_{d(on)}, t_r, t_{d(off)}, t_f - I_C$

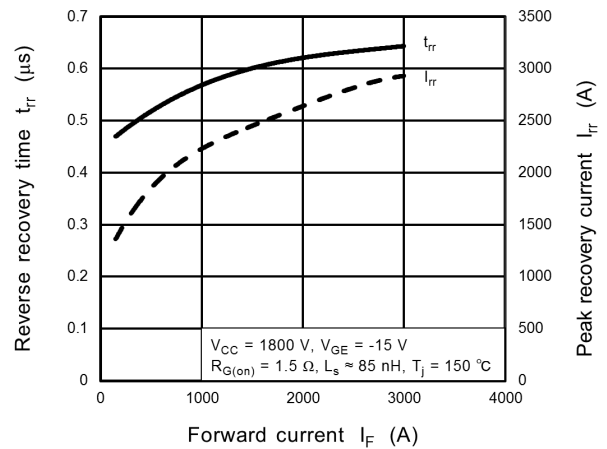


Fig. 7.10 $t_{rr}, I_{rr} - I_F$

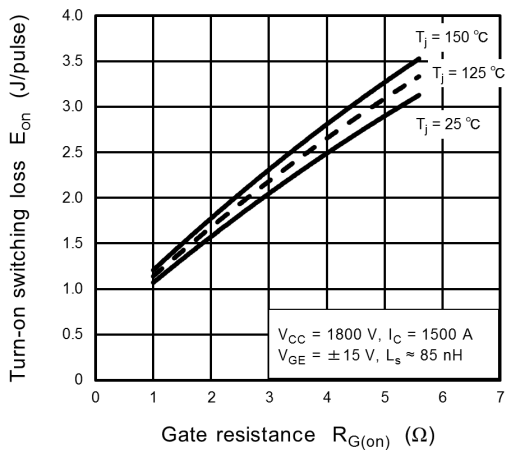


Fig. 7.11 $E_{on} - R_{G(on)}$

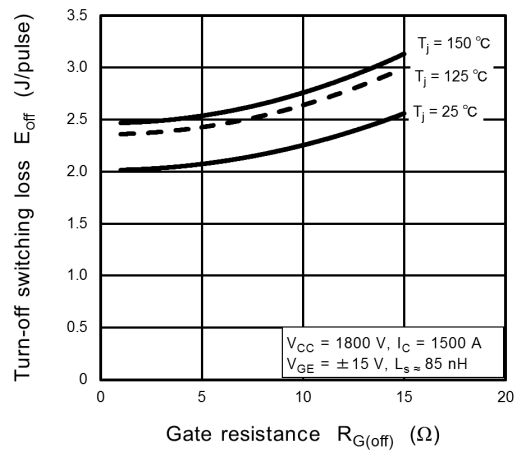


Fig. 7.12 $E_{off} - R_{G(off)}$

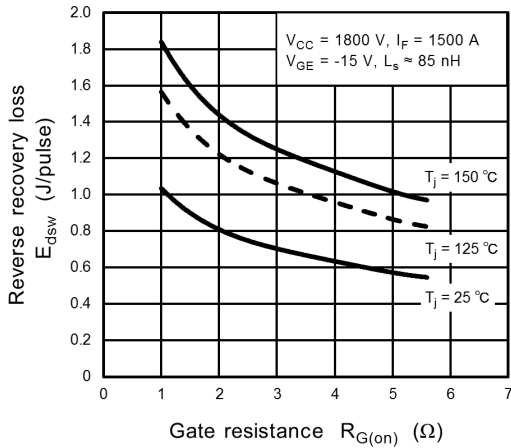


Fig. 7.13 $E_{dsw} - R_{G(on)}$

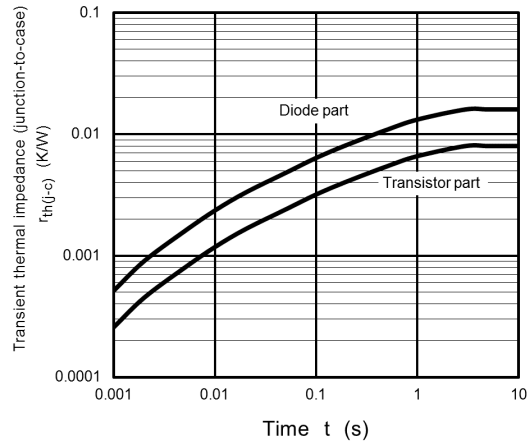


Fig. 7.14 $R_{th(j-c)} - t$ (Guaranteed Maximum)

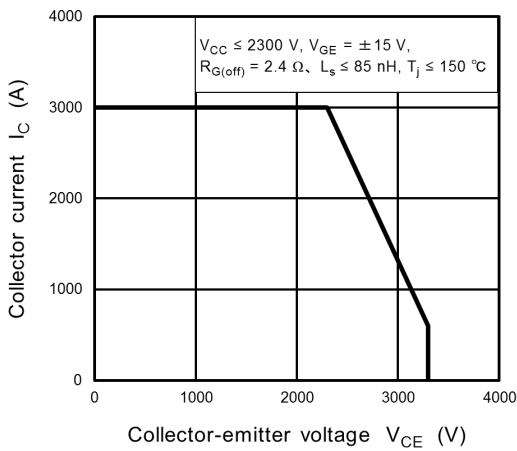


Fig. 7.15 RBSOA(Guaranteed Maximum)

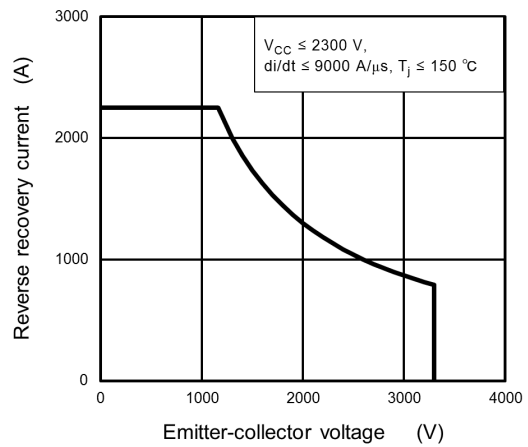
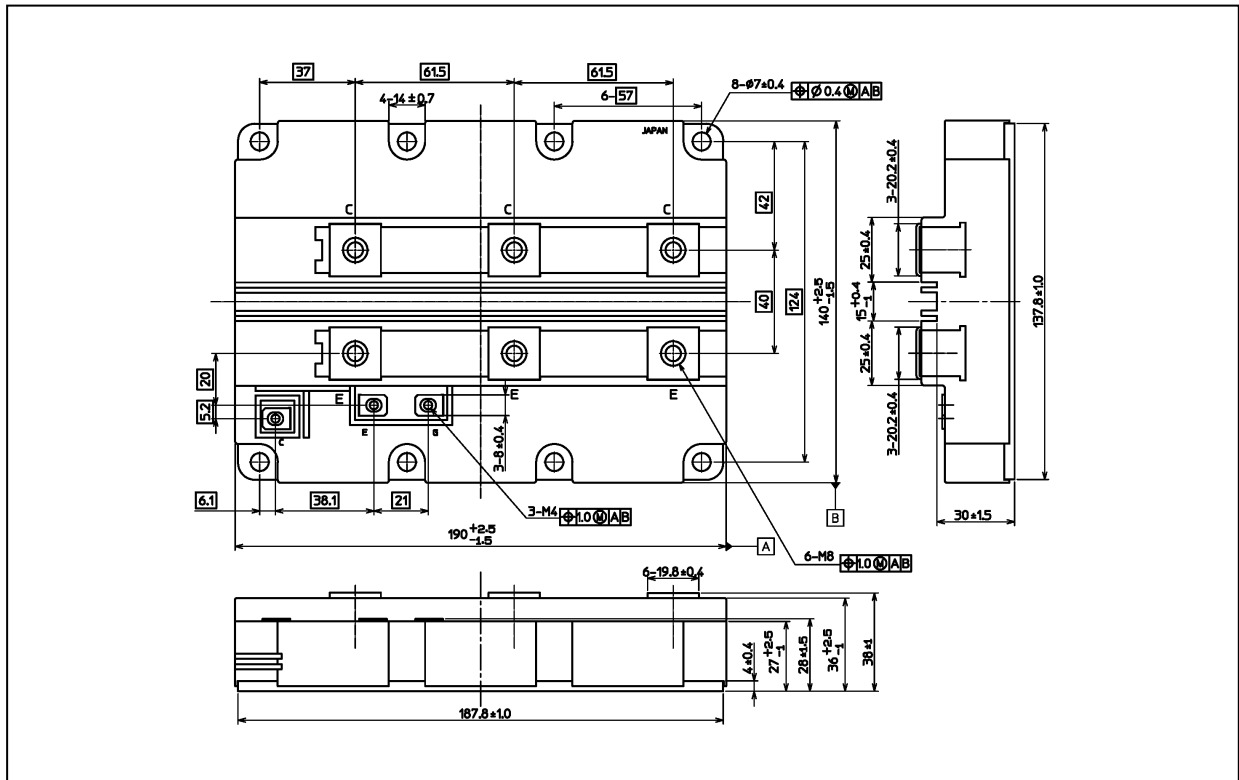


Fig. 7.16 RRSOA(Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1200 g (typ.)

Package Name(s)
TOSHIBA: 2-193D1A
Nickname: PMI193D

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